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April 1st, 2010 Renesas Electronics Corporation

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HAT2210R, HAT2210RJ

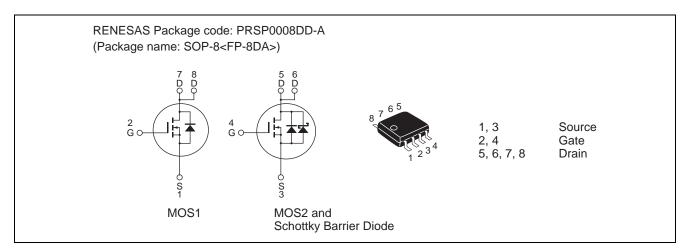
Silicon N Channel Power MOS FET with Schottky Barrier Diode High Speed Power Switching

> REJ03G0578-0300 Rev.3.00 Mar.15.2005

Features

- Low on-resistance
- Capable of 4.5 V gate drive
- High density mounting
- Built-in Schottky Barrier Diode

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item		Ratings					
	Symbol	HAT2	2210R	HAT2	Unit		
		MOS1	MOS2 & SBD	MOS1	MOS2 & SBD		
Drain to source voltage	V _{DSS}	30	30	30	30	V	
Gate to source voltage	V _{GSS}	±20	±12	±20	±12	V	
Drain current	I _D	7.5	8.0	7.5	8.0	Α	
Drain peak current	I _{D(pulse)} Note1	60	64	60	64	Α	
Reverse drain current	I _{DR}	7.5	8.0	7.5	8.0	Α	
Avalanche current	I _{AP} Note 2	_	_	7.5	8.0	Α	
Avalanche energy	E _{AR} Note 2	_	_	5.62	6.4	mJ	
Channel dissipation	Pch Note3	1.5	1.5	1.5	1.5	W	
Channel temperature	Tch	150	150	150	150	°C	
Storage temperature	Tstg	-55 to +150	-55 to +150	-55 to +150	-55 to +150	°C	

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1 %

- 2. Value at Tch = 25°C, Rg \geq 50 Ω
- 3. 1 Drive operation; When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW \leq 10 s

Electrical Characteristics

• MOS1

 $(Ta = 25^{\circ}C)$

Item		Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage		V _{(BR)DSS}	30	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current		I _{GSS}	_	_	±0.1	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current		I _{DSS}	_	_	1	μΑ	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Zero gate voltage drain current	HAT2210R	I _{DSS}	_	_	_	μΑ	$V_{DS} = 24 \text{ V}, V_{GS} = 0,$
	HAT2210RJ	I _{DSS}	_	_	10	μΑ	Ta = 125°C
Gate to source cutoff voltage		V _{GS(off)}	1.0	_	2.5	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$
Static drain to source on state		R _{DS(on)}	_	19	24	mΩ	$I_D = 3.75 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$
resistance		R _{DS(on)}	_	27	40	mΩ	$I_D = 3.75 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$
Forward transfer admittance		y _{fs}	9	15	_	S	$I_D = 3.75 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance		Ciss	_	630	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance		Coss	_	155	_	pF	f = 1MHz
Reverse transfer capacitance		Crss	_	57	_	pF	
Total gate charge		Qg	_	4.6	_	nC	$V_{DD} = 10 \text{ V}, V_{GS} = 4.5 \text{ V},$
Gate to source charge		Qgs	_	2.2	_	nC	$I_D = 7.5 A$
Gate to drain charge		Qgd	_	1.2	_	nC	
Turn-on delay time		t _{d(on)}	_	7	_	ns	$V_{GS} = 10 \text{ V}, I_D = 3.75 \text{ A},$
Rise time		t _r	_	14	_	ns	$V_{DD} \approx 10 \text{ V}, \text{ R}_{L} = 2.66 \Omega,$
Turn-off delay time		t _{d(off)}	_	36	_	ns	$R_g = 4.7 \Omega$
Fall time		t _f	_	3.4		ns	
Body-drain diode forward voltage		V_{DF}	_	0.85	1.11	V	$IF = 7.5 \text{ A}, V_{GS} = 0^{\text{Note4}}$
Body-drain diode reverse		t _{rr}	_	17	_	ns	IF =7.5 A, V _{GS} = 0
recovery time							diF/ dt = 100 A/μs

Notes: 4. Pulse test

MOS2 & Schottky Barrier Diode

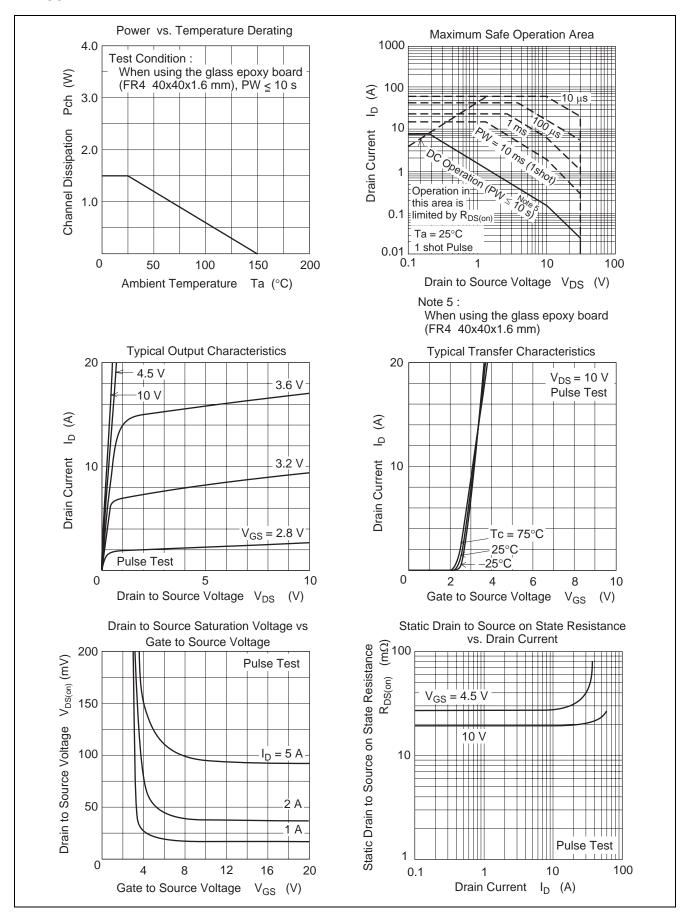
 $(Ta = 25^{\circ}C)$

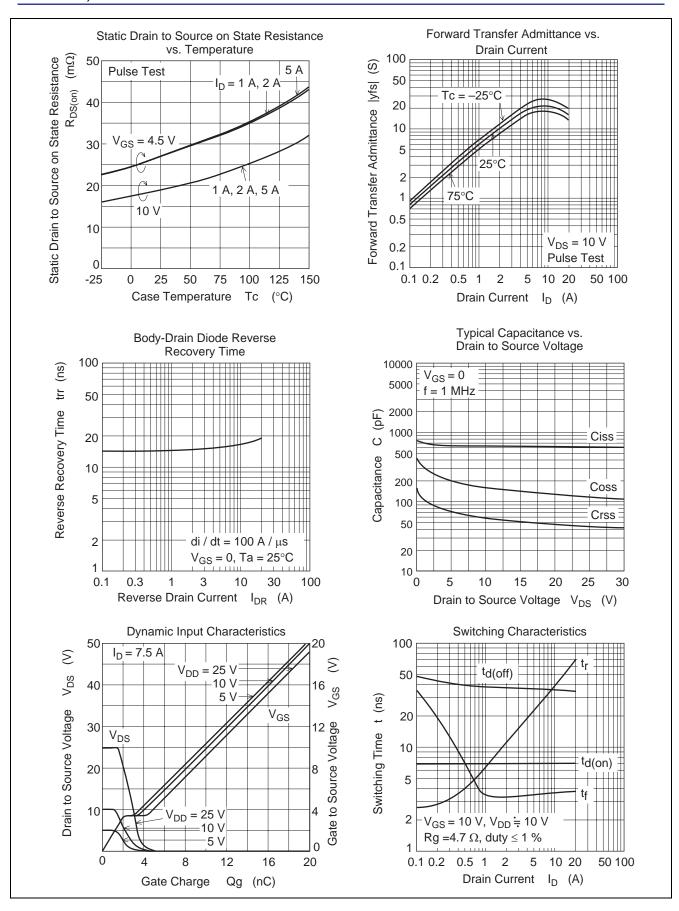
Item	Symbol	Min	Тур	Max	Unit	Test Conditions	
Drain to source breakdown voltage	V _{(BR)DSS}	30	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$	
Gate to source leak current	I_{GSS}	_		±0.1	μΑ	$V_{GS} = \pm 12 \text{ V}, V_{DS} = 0$	
Zero gate voltage drain current	I_{DSS}	_	_	1	mA	$V_{DS} = 30 \text{ V}, V_{GS} = 0$	
Gate to source cutoff voltage	$V_{GS(off)}$	1.4	_	2.5	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$	
Static drain to source on state	R _{DS(on)}	_	17	22	mΩ	$I_D = 4 A$, $V_{GS} = 10 V^{Note4}$	
resistance	R _{DS(on)}	_	21	29	mΩ	$I_D = 4 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$	
Forward transfer admittance	y _{fs}	15	25	_	S	$I_D = 4 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$	
Input capacitance	Ciss	_	1330	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$	
Output capacitance	Coss	_	230	_	pF	f = 1MHz	
Reverse transfer capacitance	Crss	_	92	_	pF		
Total gate charge	Qg	_	11	_	nC	$V_{DD} = 10 \text{ V}, V_{GS} = 4.5 \text{ V},$	
Gate to source charge	Qgs	_	3.8	_	nC	$I_D = 8 A$	
Gate to drain charge	Qgd	_	3.2	_	nC		
Turn-on delay time	t _{d(on)}	_	10	_	ns	$V_{GS} = 10 \text{ V}, I_D = 4 \text{ A},$	
Rise time	t _r	_	16	_	ns	$V_{DD} \approx 10 \text{ V}, \text{ R}_{L} = 2.5 \Omega,$	
Turn-off delay time	$t_{d(off)}$	_	43	_	ns	$R_g = 4.7 \Omega$	
Fall time	t _f	_	3.9	_	ns		
Schottky Barrier diode forward voltage	V _F		0.5		V	$IF = 3.5 A, V_{GS} = 0^{Note4}$	
Body-drain diode reverse	t _{rr}	_	15	_	ns	IF = 8 A, V _{GS} = 0	
recovery time						diF/ dt = 100 A/μs	

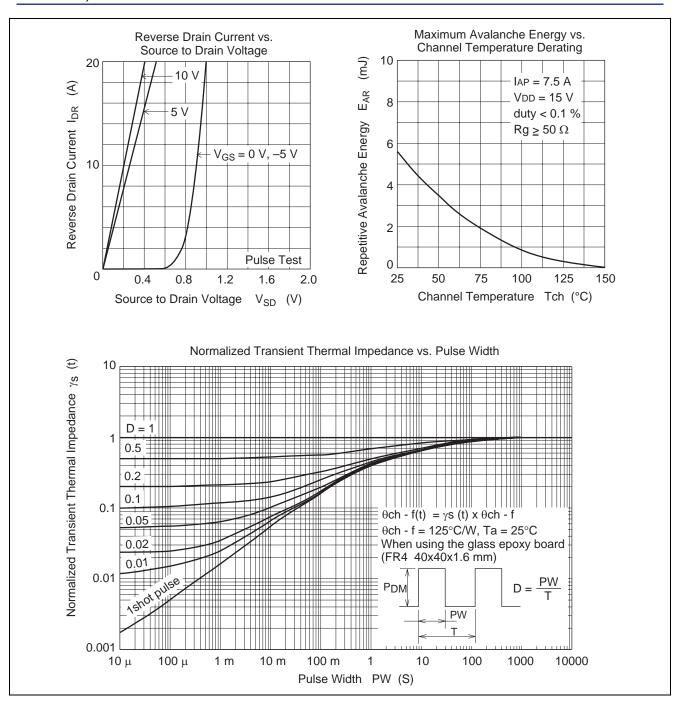
Notes: 4. Pulse test

Main Characteristics

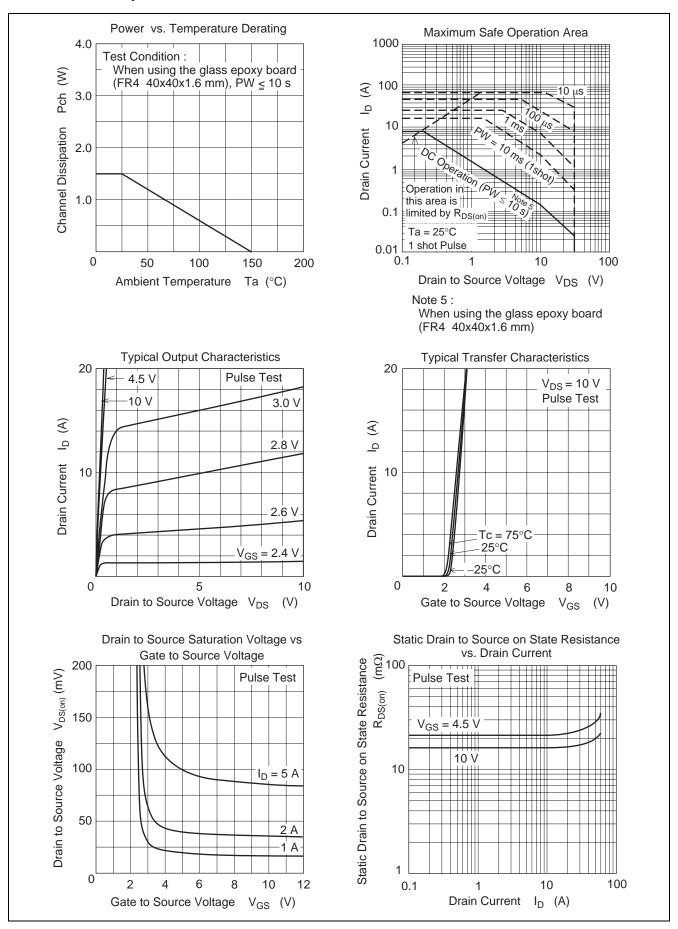
• MOS1

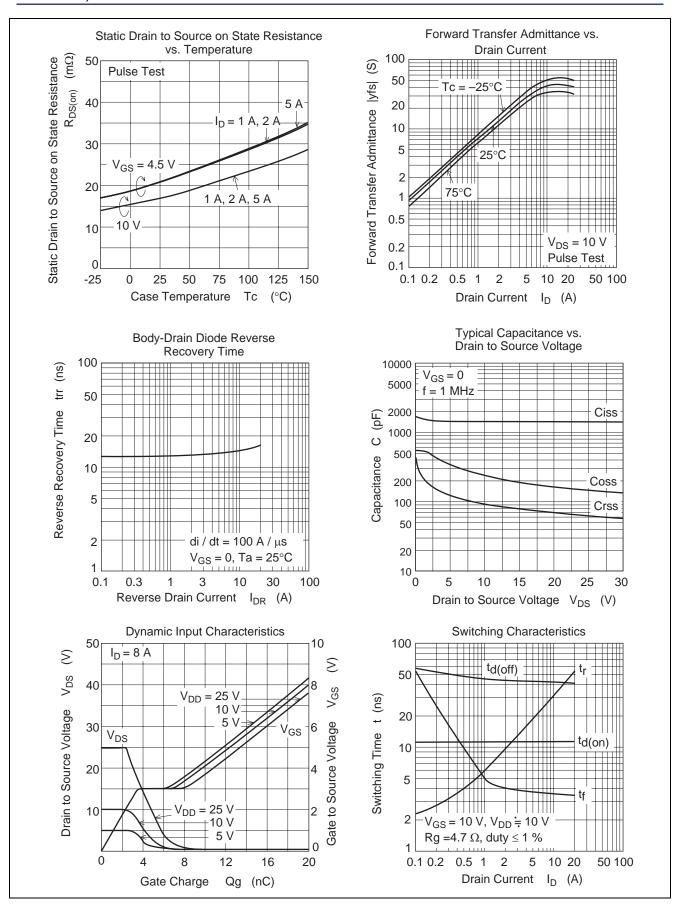


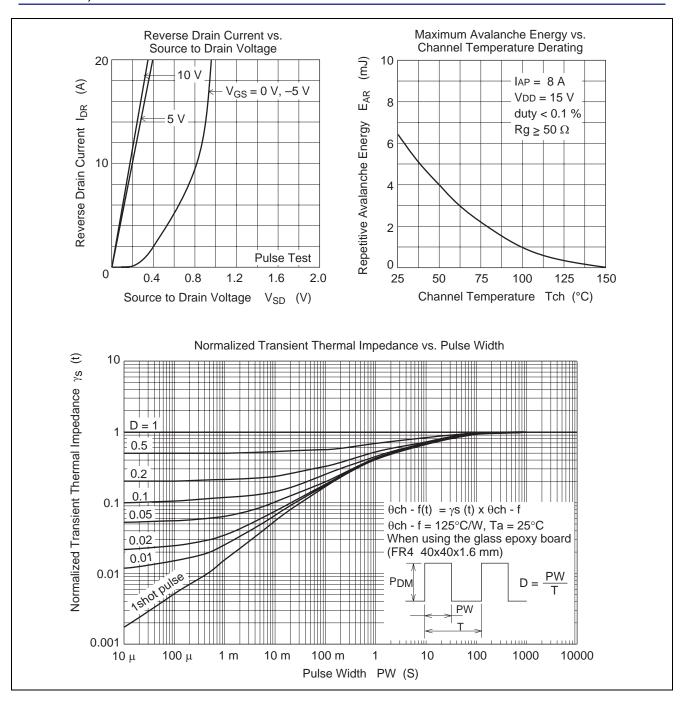




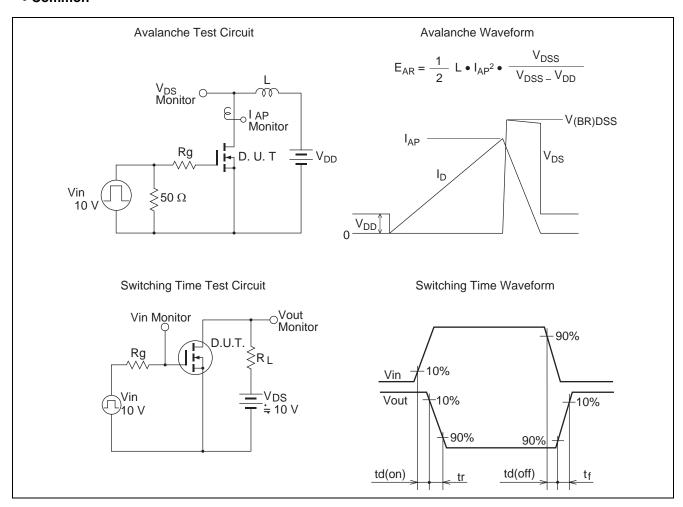
• MOS2 & Schottky Barrier Diode



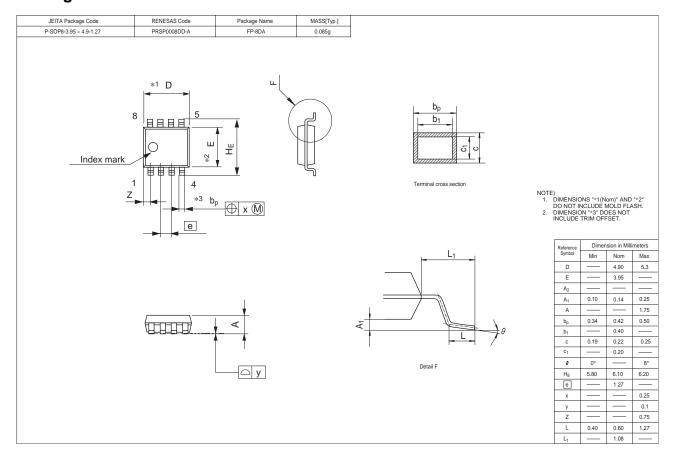




• Common



Package Dimensions



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Part Name	Quantity	Shipping Container
HAT2210R-EL-E	2500 pcs	Taping
HAT2210RJ-EL-E	2500 pcs	Taping

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